

# CEPFZ44/CEBFZ44

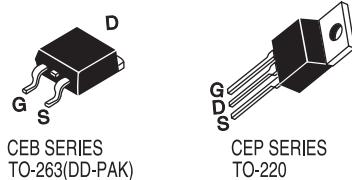
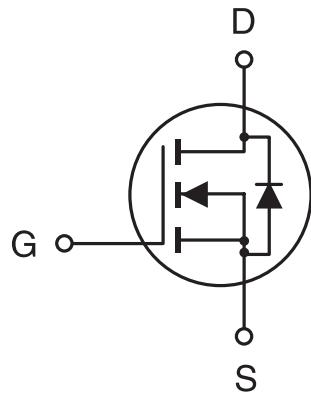
March 1998

## N-Channel Enhancement Mode Field Effect Transistor

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### FEATURES

- 55V , 60A ,  $R_{DS(ON)}=25m\Omega$  @  $V_{GS}=10V$
- Super high dense cell design for extremely low  $R_{DS(ON)}$ .
- High power and current handling capability.
- TO-220 & TO-263 package.



### ABSOLUTE MAXIMUM RATINGS (Tc=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	$V_{DS}$	55	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Drain Current-Continuous -Pulsed	$I_D$	60	A
	$I_{DM}$	144	A
Drain-Source Diode Forward Current	$I_S$	60	A
Maximum Power Dissipation @ Tc=25°C Derate above 25°C	$P_D$	100	W
		0.7	W/°C
Operating and Storage Temperature Range	$T_J, T_{STG}$	-65 to 175	°C

### THERMAL CHARACTERISTICS

Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	2	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	62.5	°C/W

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## ELECTRICAL CHARACTERISTICS (T<sub>c</sub>=25°C unless otherwise noted)

4

Parameter	Symbol	Condition	Min	Typ	Max	Unit
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	55			V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =55V, V <sub>GS</sub> =0V			25	μA
Gate-Body Leakage	I <sub>GSS</sub>	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V			±100	nA
<b>ON CHARACTERISTICS<sup>a</sup></b>						
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	2	2.8	4	V
Drain-Source On-State Resistance	R <sub>D(S)</sub> (ON)	V <sub>GS</sub> =10V, I <sub>D</sub> =24A		19	25	mΩ
On-State Drain Current	I <sub>D(ON)</sub>	V <sub>GS</sub> =10V, V <sub>DS</sub> =10V	60			A
Forward Transconductance	g <sub>FS</sub>	V <sub>DS</sub> =10V, I <sub>D</sub> =24A		20		S
<b>DYNAMIC CHARACTERISTICS<sup>b</sup></b>						
Input Capacitance	C <sub>ISS</sub>	V <sub>DS</sub> =25V, V <sub>GS</sub> =0V f=1.0MHz		1178	1600	pF
Output Capacitance	C <sub>OSS</sub>			428	560	pF
Reverse Transfer Capacitance	C <sub>rss</sub>			95	130	pF
<b>SWITCHING CHARACTERISTICS<sup>b</sup></b>						
Turn-On Delay Time	t <sub>D(ON)</sub>	V <sub>DD</sub> =30V, I <sub>D</sub> =48A, V <sub>GS</sub> =10V, R <sub>GEN</sub> =7.5Ω		15	20	ns
Rise Time	t <sub>r</sub>			250	300	ns
Turn-Off Delay Time	t <sub>D(OFF)</sub>			45	60	ns
Fall Time	t <sub>f</sub>			60	150	ns
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> =48V, I <sub>D</sub> =48A, V <sub>GS</sub> =10V		35	70	nC
Gate-Source Charge	Q <sub>gs</sub>			12		nC
Gate-Drain Charge	Q <sub>gd</sub>			7		nC

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## ELECTRICAL CHARACTERISTICS ( $T_c=25^\circ\text{C}$ unless otherwise noted)

4

Parameter	Symbol	Condition	Min	Typ	Max	Unit
<b>DRAIN-SOURCE DIODE CHARACTERISTICS <sup>a</sup></b>						
Diode Forward Voltage	$V_{SD}$	$V_{GS} = 0\text{V}$ , $I_S = 24\text{A}$		0.9	1.3	V

### Notes

- a. Pulse Test: Pulse Width  $\leq 300\ \mu\text{s}$ , Duty Cycle  $\leq 2\%$ .
- b. Guaranteed by design, not subject to production testing.

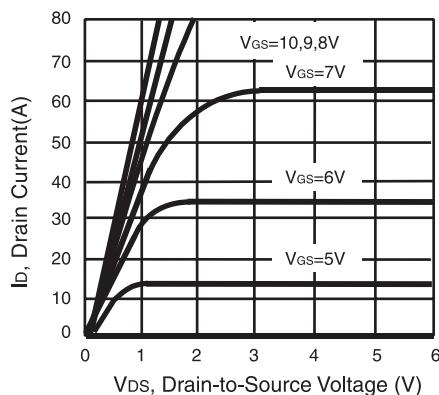


Figure 1. Output Characteristics

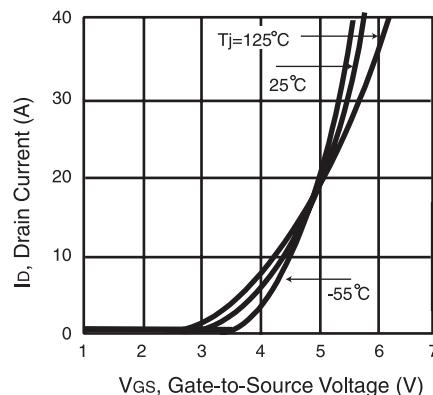


Figure 2. Transfer Characteristics

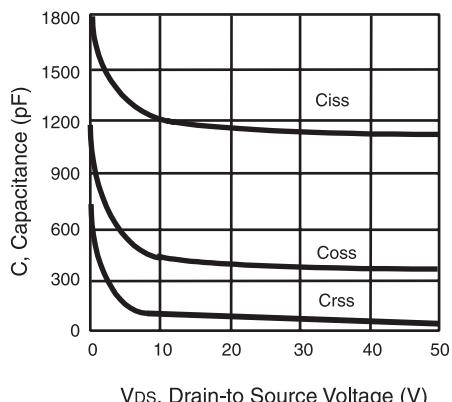


Figure 3. Capacitance

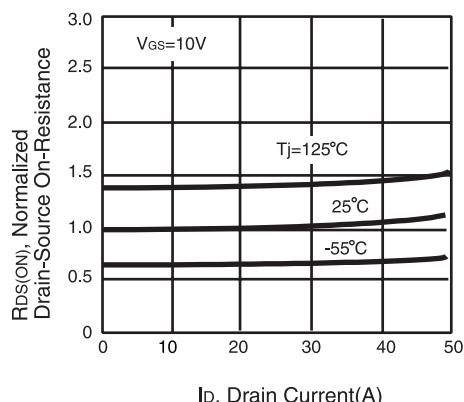
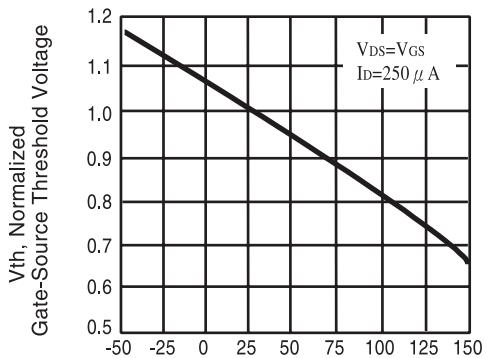


Figure 4. On-Resistance Variation with Drain Current and Temperature

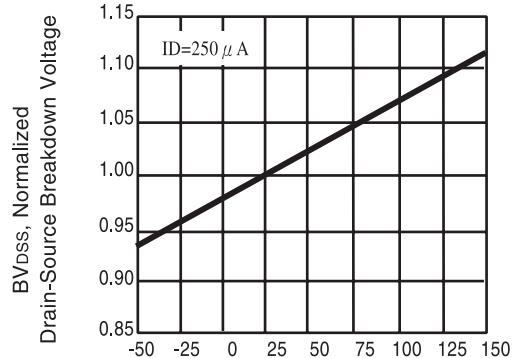
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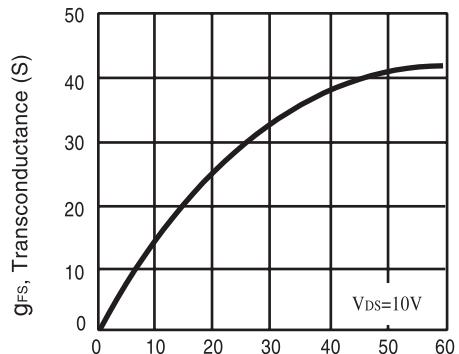
T<sub>j</sub>, Junction Temperature (°C)

**Figure 5. Gate Threshold Variation with Temperature**



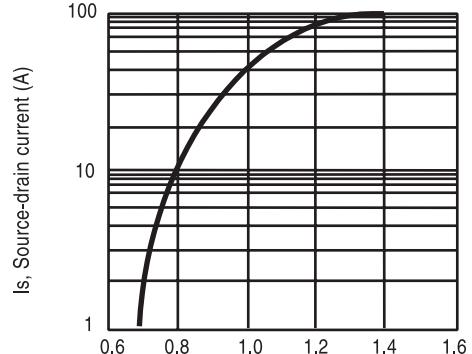
T<sub>j</sub>, Junction Temperature (°C)

**Figure 6. Breakdown Voltage Variation with Temperature**



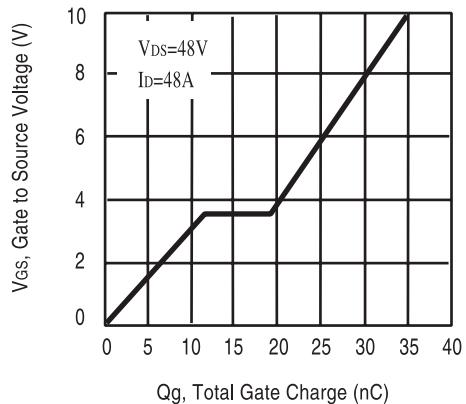
I<sub>D</sub>, Drain-Source Current (A)

**Figure 7. Transconductance Variation with Drain Current**



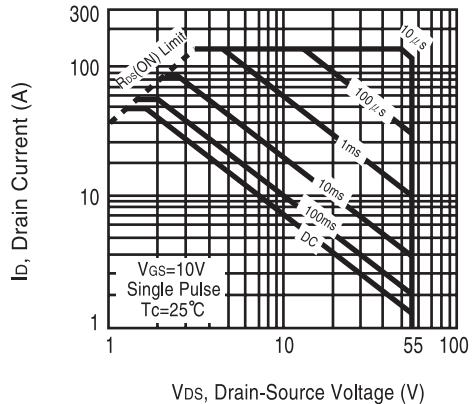
V<sub>sd</sub>, Body Diode Forward Voltage (V)

**Figure 8. Body Diode Forward Voltage Variation with Source Current**



Q<sub>g</sub>, Total Gate Charge (nC)

**Figure 9. Gate Charge**



V<sub>ds</sub>, Drain-Source Voltage (V)

**Figure 10. Maximum Safe Operating Area**

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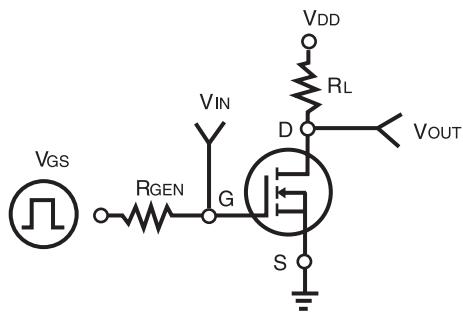


Figure 11. Switching Test Circuit

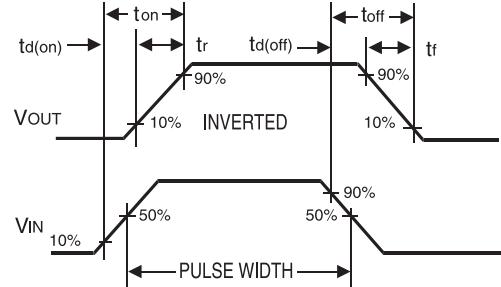


Figure 12. Switching Waveforms

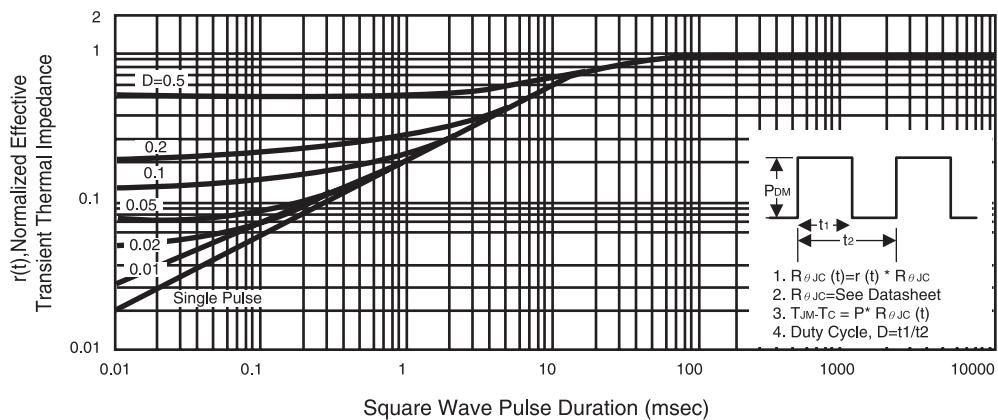


Figure 13. Normalized Thermal Transient Impedance Curve